

SPECIFICATION 产品规格书

Part No 品號: N0W13S31

♦Outline (L*W*H) : 3.5*2.8*1.9mm

◆Specification: T40120A20D06000

APPROVED SIGNATURES

顧客確認

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3、Features

- § forward current ≤30mA
- § Wide viewing angle:120°
- § Operating Temperature -30~80°C
- § Storage temperature-40~100°C
- § Junction Temperature110°C
- § ROHS and REACH-compliant
- § PACKAGE:2000 PCS/REEL.
- § Qualified according to JEDEC moisturevity Level 3
- § Chip material: InGaN

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§ Reverse Voltage:5V

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4、Electrical-Optical Characteristics (Ta=25°€)

Parameter	Symbol		Value	Unit	Test	
Parameter	Syllibol	Min.	Тур.	Max.	Onit	condition
Forward Voltage	Vf	2.8	3.2	3.6	V	lf=20mA
Luminous intensity	lv	1450	1850	,	mcd	lf=20mA
Mayalanath	Х		0.5083			lf=20mA
Wavelength	у		0.4145		\	lf=20mA
Reverse Current	lr			10	μΑ	Vr=5V
Viewing angle	201/2		120		Deg	lf=20mA

 \blacktriangle 1.Luminous intensity (IV) \pm 10%, Forward Voltage (VF) \pm 0.1V, Wavelength(X,Y) \pm 0.01

▲ 2.IS standard testing

5. Range of bins

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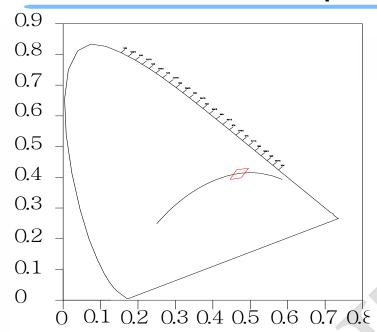
Bin	BinB	BinC	BinD	BinE	BinF	BinG	BinH
VF(V)	2.8-2.9	2.9-3.0	3.0-3.1	3.1-3.2	3.2-3.3	3.3-3.4	3.4-3.5
Bin	Binl						
VF(V)	3.5-3.6						
Bin	Bin3	Bin4	Bin5	Bin6	Bin7		
lv(mcd)	1450-1650	1650-1850	1850-2050	2050-2250	2250-2450		
Bin		_					
WL(nm)	YY4-5ab						

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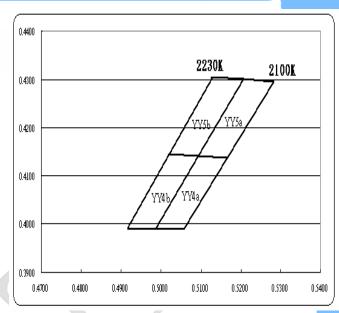
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6. Color Coordinate Comparison



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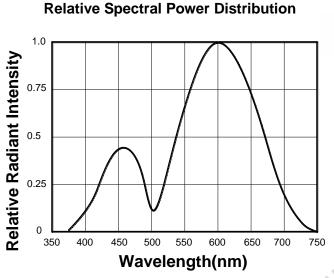


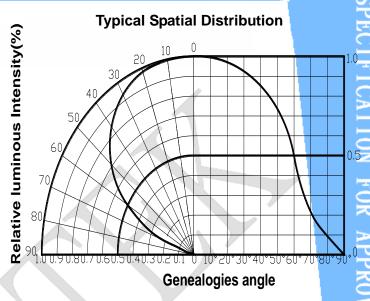
BIN碼	Х	Y	Х	Y	X	Y	Х	Y
YY4a	0.5094	0.4141	0.4986	0.3990	0.5057	0.3990	0.5166	0.4137
YY5a	0.5207	0.4301	0.5094	0.4141	0.5166	0.4137	0.5283	0.4295
ҮҮ4Ь	0.5021	0.4145	0.4915	0.3990	0.4986	0.399	0.50935	0.4141
ҮҮ 5Ъ	0.5130	0.4306	0.5021	0.4145	0.50935	0.4141	0.52065	0.43005

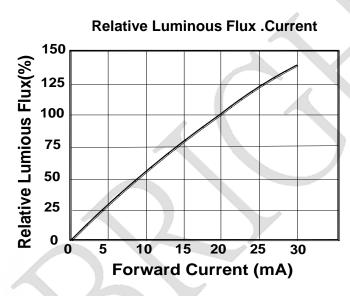
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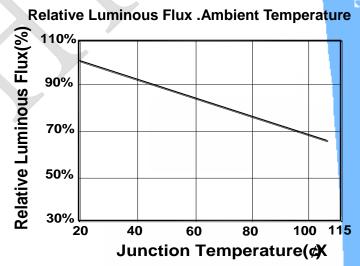
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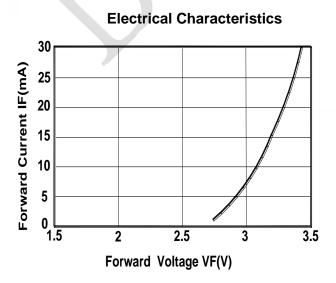
7. Optical Characteristics-1

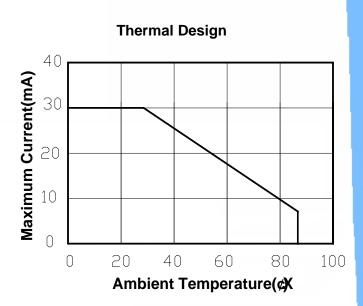










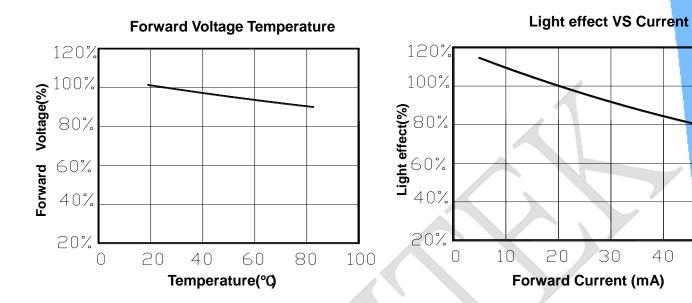


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8. Optical Characteristics-2

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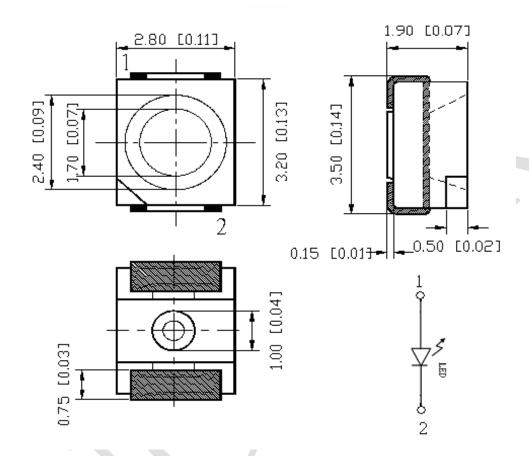


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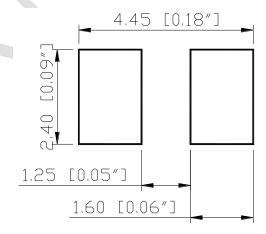
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9. Outline Dimensions



RECOMMEND PADLAYOUT



- § All dimensions are in millimeters (inches).
- § Tolerance is $\pm 0.1(0.004)$ mm unless otherwise noted.
- § Specifications are subject to change without notice.

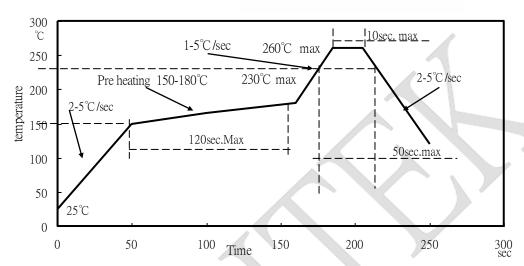
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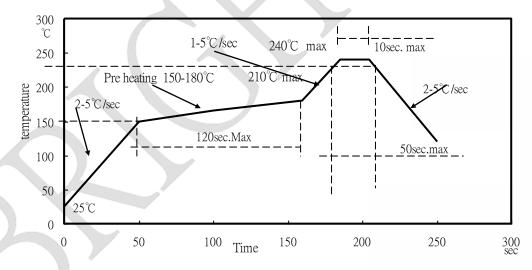
10 Reflow Profile

1. IR reflow soldering Profile Lead Free solder



2.IR reflow soldering Profile

Lead solder



NOTES:

1.We recommend the reflow temperature 240 $^{\circ}$ C(±5 $^{\circ}$ C).the maximum soldering temperature should be limited to 260 $^{\circ}$ C.

Documents No:

- 2.Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 1 time.

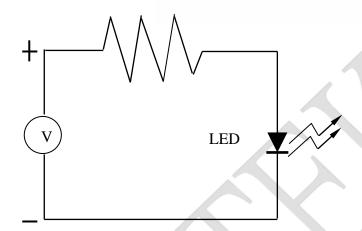
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11 Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°€30°(41°¥86°)F

2.2 Shelf life in sealed bag: 12 month at <5°€30°and <60% R.H. after the package is

Opened, the products should be used within a week or they should be keeping to stored at

\$20%R.H. with zip-lock sealed.

3.Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs. The Conditions are as followings:

- 3.1 70±3°C x 24hrs and <5%RH, taped reel type
- 3.2 100±3°& 2hrs, bulk type
- 3.3 130±3°&(15~30min), bulk type

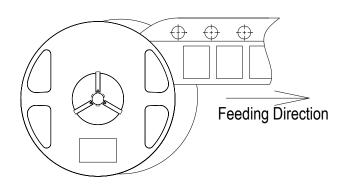
It shall be normal to see slight color fading of carrier(light yellow) after baking in process

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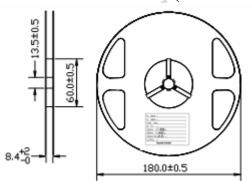


12 Packing-1

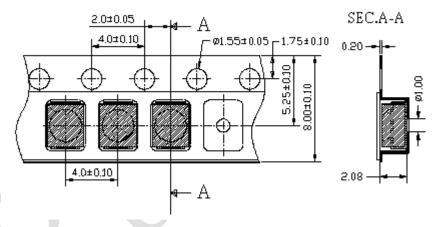
3528 Single-Color High Performance SMD Top LEDs Packaging Specifications



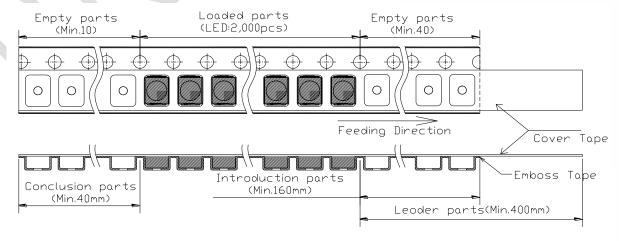
• Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape



NOTES

- 1. Empty component pockets are sealed with top cover tape;
 - 2. The maximum number of missing lamps is two;
- The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;

4. 2,000pcs/Reel

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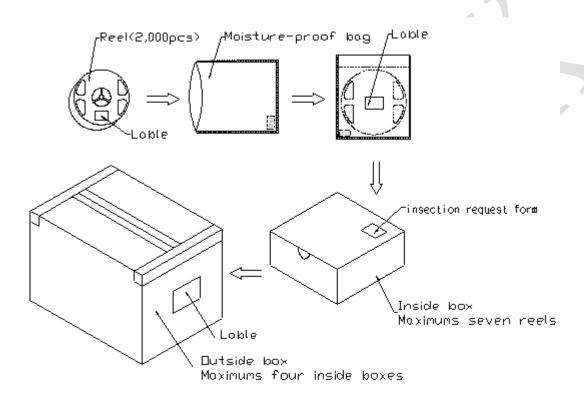
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12、Packing-2

3528 Single-Color High Performance SMD Top LEDs Packaging Specifications

Packaging specifications



NOTES:

Reeled products (The most numbers of products are 2,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 14,000pcs) packed in an inside box (size: about 260mm x about 230mm x about 100mm) and four inside boxes of maximums are put in the outside box (size: about 480mm x about 275mm x about 215mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the in section request form on the cardboard box.).

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13 Precautions

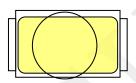
1 · Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

2 Now to choose the collet

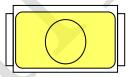
During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out:..

> Outer diameter of collet should be larger than the lighting area



Picture 1 $(\sqrt{})$

Outer diameter of collet



Picture 2 (x)

3 Now to set the height of collet

The reason why for top view SMD, the height of collet before it presses downward will directly affect the quality of products during SMT is that if the collect go down too much, it will press lens and cause the distortion or breaking of gold wire. The setting of collet position should follow the pictures belowed.



Picture 3 $(\sqrt{})$



Picture 4 (x)

No.3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

No.4. This usage and handling instruction is only for your reference.

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14. Test items and results of reliability

Туре	Type Test Item		Test Conditions	Note	Number of Damaged
	Temperature Cycle	JEITA ED-4701 300 303	-40°G0min ↑↓5 min 100°G0min	100 cycle	0/50
ıntal	Thermal Shock	JEITA ED-4701 200 303	-10°₫5min ↑↓5sec 100°₫5min	20 cycle	0/22
Environmental Sequence	High Temperature Storage	JEITA ED-4701 200 201	T _a =100°C	1000 hrs	0/22
E E	Humidity Heat Storage	JEITA ED-4701 100 103	T _a =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	JEITA ED-4701 200 202	T _a =-40°C	1000 hrs	0/22
	Life Test	Tested with Brightek standard	T _a =25°C I _F =20mA	1000 hrs	0/22
Operation Sequence	High Humidity Heat Life Test Standard		60°@H=90% I _F =15mA	500 hrs	0/22
	Low Temperature Life Test	Tested with Brightek standard	T _a =-20°C I _F =20mA	1000 hrs	0/22

15. Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	Vf(V)	IF=20mA	Over Ux1.2
Reverse current	I _R (uA)	Vr=5V	Over Ux2

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Revision History

Data	Revision History	40	.v4	writer		
Date		le	ext	Drawn	Approved	
2012/09/07	更新版本	2.0	2.1	高占穩		
		X				
				Y		
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